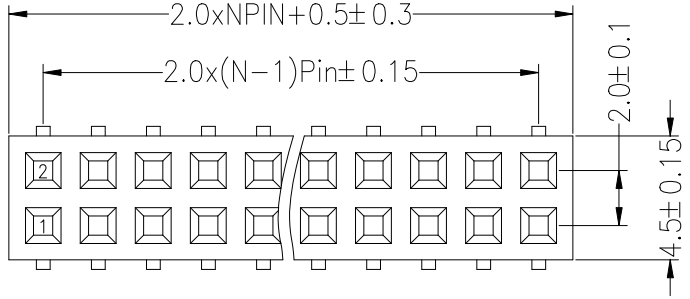
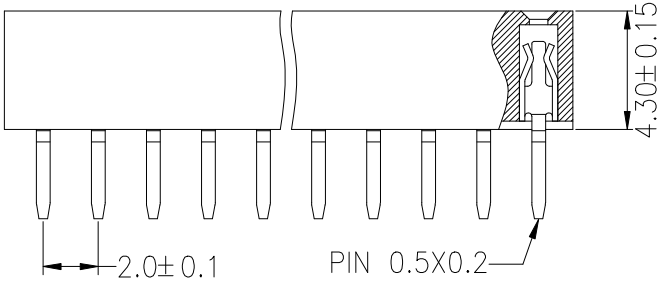
HSF RoHS

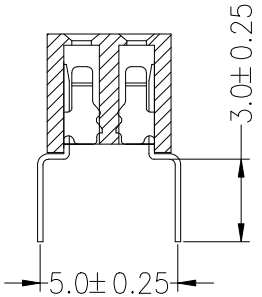
FILE NO:E362810

SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



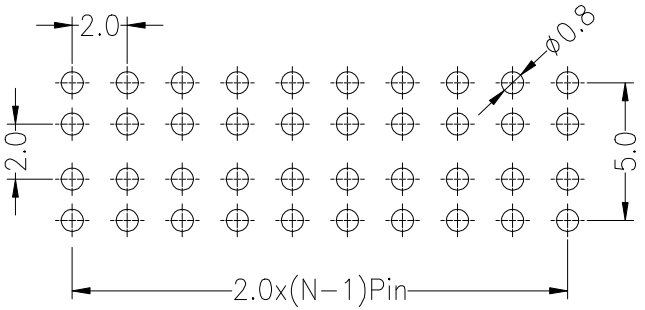




Ordering Information

2343 02 XX X N XX W U X 0X

- No.of Pins Per Row: 2−40
- Insulator Material Option: C=BK−PA6T; D=BK−PA9T; F=BK−LCP
- Contact Plating: G1:Gold Flash; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; G6:10U" Gold; G7:15U" Gold; S0:Gold Flash/Tin; SN:Tin
- Packing: A=Tray; T=Tube; P=Tube+Cap; R=Reel+Cap



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2020.09.21	NEW DRAWING	

OPERATION		DRAW	Liu Miao	20.09.21	SCALE	FIT
X.X	± 0.30				UNIT	mm
X.XX	± 0.20	CHECK			SIZE	A4
X.XXX	± 0.10				SHEET	1/1
Angle	± 3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	234302XXXNXXWUX0X
TITLE:	2.00PF H4.3mm 2xNpin Bottom Entry 5.0mm 脚宽5.0